

Unit-I

Review of semi-conductor in physics:

Open-circuited p-n junction

Diode equation:

PN diode as Rectifier (Forward and reverse bias):

Voltage Characteristics:

BJT as an amplifier and as switch:

Brief idea of dc analysis:

Biassing circuits:

Small signal operation and models:

Single stage BJT amplifier:

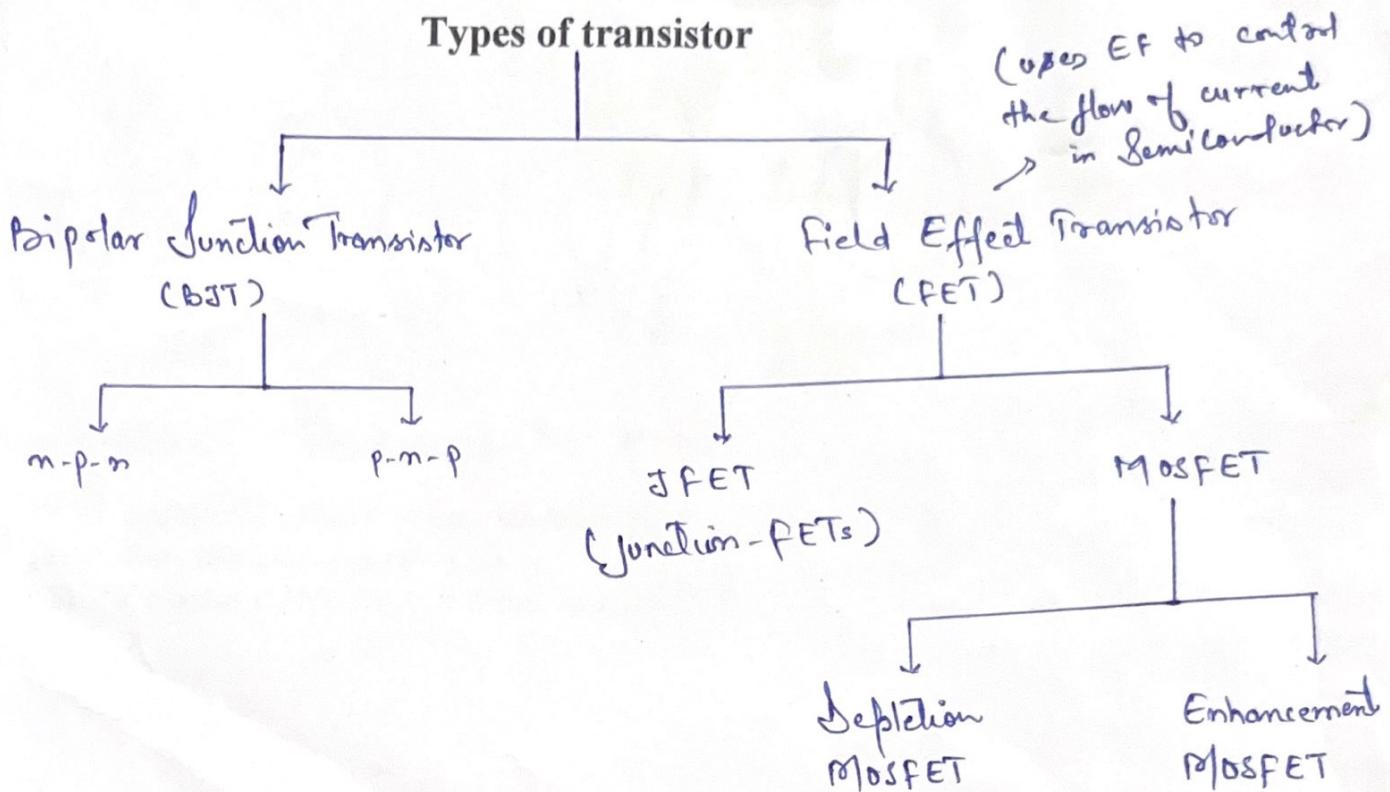
Difference between diode and transistor:

Basis For Comparison	Diode	Transistor
Definition	A semiconductor device in which current flows only in one direction.	A semiconductor device which transfers the weak signal from low resistance circuit to high resistance circuit.
Symbol		
Uses	Rectification	Regulator, Amplification and Rectification
Terminal	Two (Anode and Cathode)	Three (Emitter, Base and Collector)
Switch	Uncontrolled	Controlled
Types	Junction diode, Light emitting diode, Photodiodes, Schottky diodes, Tunnel, Varactor and Zener diode.	Bipolar transistor and Field Effect Transistor.
Region	P-region and N-region	Emitter, Collector and Base
Depletion Region	One	Two

X

Transistor:

- It was developed in the year 1947 by the three American physicists, John Bardeen, Walter Brattain and William Shockley.
- A Transistor is a three terminal semiconductor device that can be used to conduct and insulate electrical current or voltage. Generally, it is used to regulate or control the flow of electronic signals. It acts as an amplifier (e.g. radio receiver) and a switch (e.g. digital circuits).
- Transistor are inferred due to small size, light weight, no heating requirements, higher efficiency, easy to use, no warm-up period is required, lower operating voltages.



(What is BJT + What are the function or Uses of BJT)

BJT (Bipolar Junction Transistor):

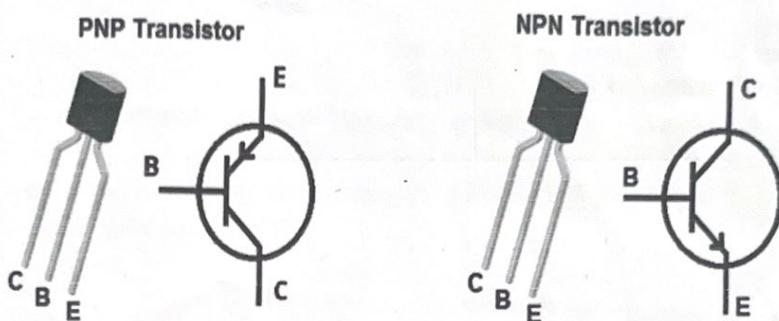
It is a three-terminal semiconductor device consisting of two p-n junctions. It is used as a switching device and for amplification of signals. It is an active device (current controlled device).



It consists of two PN junction formed by sandwiching either P-type or N-type semiconductor between a pair of opposite types (i) n-p-n (ii) p-n-p

Basics parts and symbol of a Transistor:

A transistor is composed of three layers of the semiconductor materials.

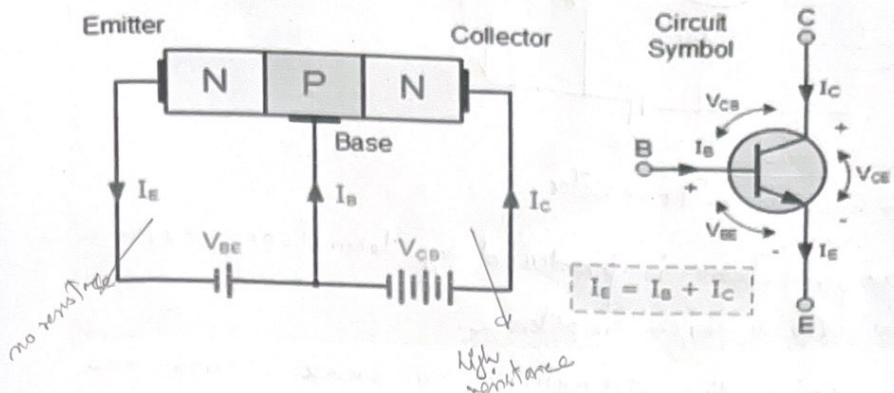


The three terminals are (Features of the terminal)

- (i) **Emitter (E):** Heavily doped, Moderate size
- (ii) **Base (B):** Lightly doped, Thin
- (iii) **Collector (C):** Moderately doped, larger/wider

(i) n-p-n type

Working:



Forward bias causes the electron ejection to flow towards the base and constitutes emitter current I_E , base electron tends to combine with the holes since base is lightly doped and very thin very few electron combines with the holes i.e., less than 5% to constituents I_B having small value in μA . Rest of the electron i.e., more than 95% cross over the collector region to constituents collector current through diffusion and minority carriers across the junction which is the because of reverse bias.

Now, according to Kirchhoff law,

$$I_E = I_B + I_C$$

The collector current is composed of the two components (i) Minority (ii) Majority

$$I_C = I_C (\text{mA}) + I_{CO} (\mu\text{A})$$

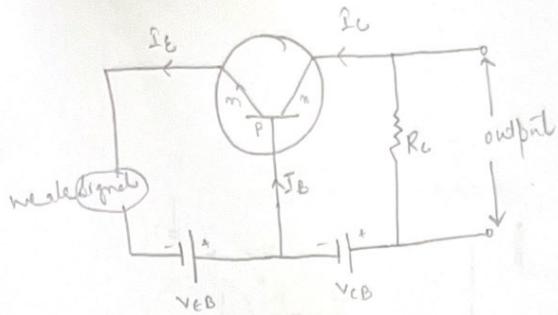
I_C (mA), is of majority current components. The minority current components is called the leakage current and represented by I_{CO} .

(ii) p-n-p type

Working:

(Do your self)

Transistor as an Amplifier: (overview)



transfer + Resistance = Transistor.

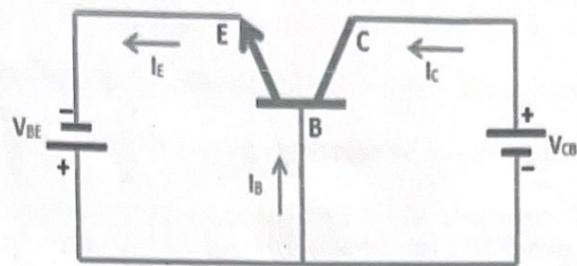
- The basic amplification is produced by transferring current I from a low to a high resistance.
 - A transistor raises the strength of a weak signal and thus act as an Amplifier. The weak signal is applied b/w E-B junction and output is taken across R_C connected in collector circuit.
 - In order to achieve faithful amplification the input circuit should always remain in forward bias. To do so a DC voltage is applied along with a varying signal the DC voltage is known as DC biased voltage and its magnitude is such that it always keep the input circuit forward biased regardless of the polarity of the signal.
- Why n-p-n configuration is preferred over p-n-p Configuration.
⇒ The mobility of electron is much higher than that of hole. as n-p-n is electron dominated configuration and p-n-p is hole dominated configuration.

Configuration of transistor :

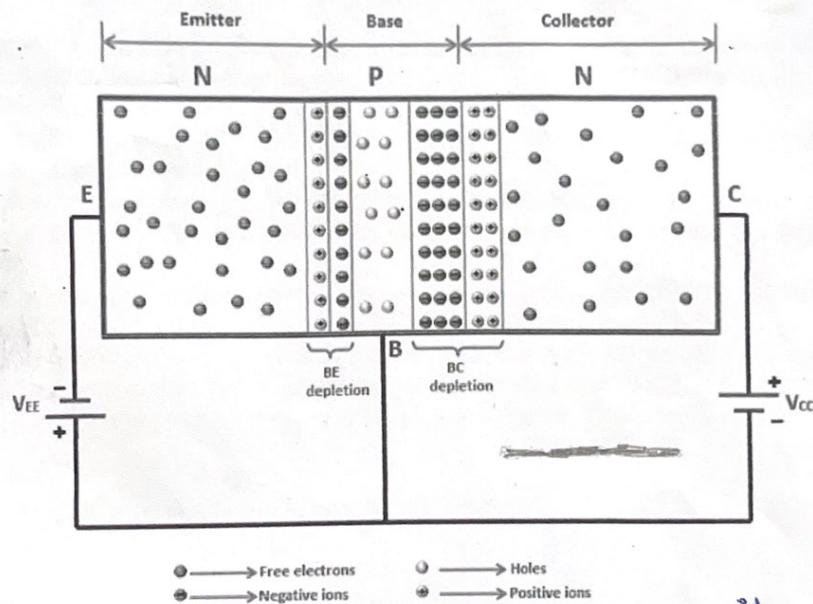
(i) Common base (CB) configuration

Common base configuration is derived from the fact that the base is common to both the input and output sides of the configuration.

(a) Construction:



(b) Working:



'How I_E , I_B and I_C are generated in the transistor circuit ?'

- In the figure you can see that base-emitter junction is in forward biased condition through the applied voltage V_{BE} and collector-base junction is in the reverse-biased state through the voltage source V_{CB} .

- I_E, I_B*
- Due to forward biasing voltage V_{BE} electrons that are major carriers in emitter will bear a force of repulsion due to negative terminal of battery also holes in the base of the transistor will bear the force of repulsion from the positive side of the voltage source.
 - Due to this electron move towards the base from emitter and holes moves from base to emitter.
 - Due to the movement of electrons and holes current flows. The real current is due to the flow of electrons which flows from emitter to base.
 - But we follow conventional current that is from base to emitter. Hence current is generated at base and emitter (I_B, I_E).
 - The electrons that move from emitter toward base will combine with a hole which is majority carriers and holes moving toward the base to emitter combine with the emitter.
 - In the above diagram, you can note that the area of the base is very less. So, less number of electrons coming from emitter will combine with holes in base remaining will enter to the collector.
 - The electrons enter into the collector will bear the force of attraction from the positive side of the battery.
 - So free electrons in collectors move to the positive side of the battery due to that current is generated at the collector region (I_C)
 - The current produced at collectors and base is due to electrons coming from the emitter. hence, emitter current is large than the collector and base current and equal to the sum of these two currents.

$$I_E = I_B + I_C$$

- gain*
- As we discuss above emitter is input and collector is output.
 - As output or collector current is less than the emitter current hence gain of current is less than the one. ($\text{gain} = \frac{\text{output}}{\text{input}}$)
 - In simple words, a common base amplifier attenuates current *other than* amplification of it.
 - As the base-emitter junctions at input operate as a forward-biased diode. So the impedance of a common base amplifier at the input is less.
 - The collector-base junction behaves like a reverse-biased diode due to this impedance for a common base at the output is high.
 - So we can conclude that input impedance for the common base is less and high at the output.
 - Such a transistor that has less input impedance and large output impedance give large voltage gain.
 - As the gain is large but the current is less so the power gain of this amplifier is less than other amplifiers.
 - These amplifiers are used in such an application where less input is needed.
 - Base amplifier configuration is mostly used in the current buffer circuit.
 - This amplifier is not commonly used as a common emitter and collector is used.

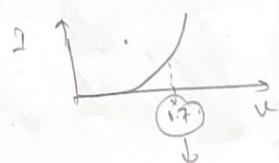
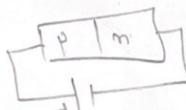
Input Characteristics: (variation of current with voltage)

Current: I_E

Voltage: V_{BE}

For various output voltage (V_{CB})

In case of simple diode



breakdown $\rightarrow 0.7\text{V}$ for Silicon
voltage

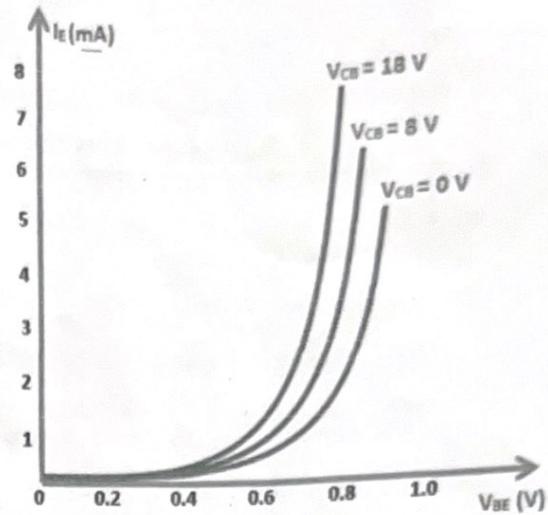
$V_{IB} \rightarrow V_{BE}$ \rightarrow Depletion region (V_{BE}) \rightarrow Recombination layer
 Ideals \downarrow more at now & moves toward collector
 here I_E increases.

Why I_E increases with increasing V_{CB} ?

As the V_{CB} is in the reversed bias so increasing the V_{CB} values the reverse bias increases which results in thicker BC depletion regions and the base becomes much thinner. Thus, less recombination takes at the base and more electron moves toward the collector, resulting in higher I_E .

Input resistance:

$$r_i = \frac{\Delta V_{BE}}{\Delta I_E} \quad | \text{at const. } V_{CB}$$



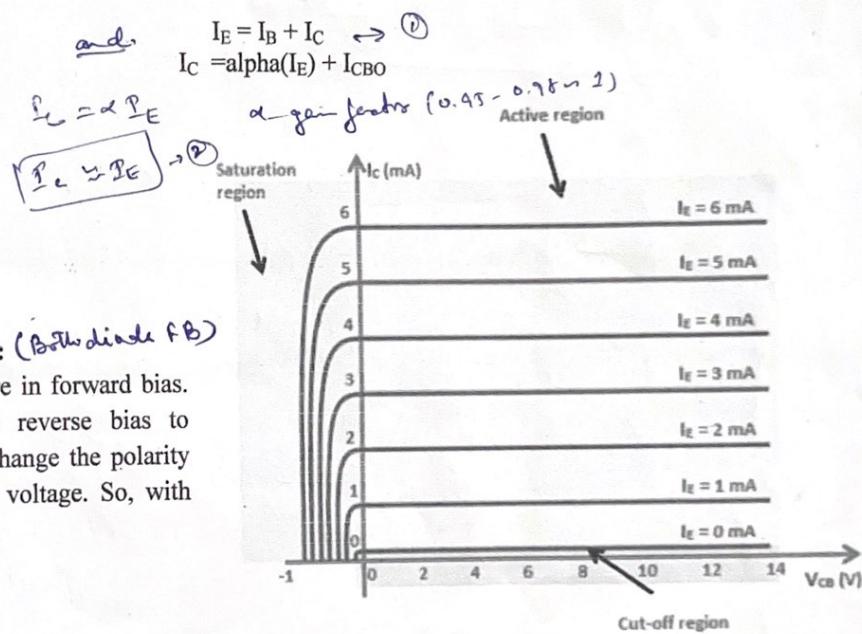
Output characteristics:

Current: I_C

Voltage: V_{CB}

For various input current (I_E)

Before the characteristics let us understand



Saturation region: (Both diode FB)

Both the diodes are in forward bias. So, to make the reverse bias to forward bias we change the polarity by decreasing the voltage. So, with

decrease in the V_{CB} voltage the I_C current decreases. Because the electron from the emitter are now restricted because of the forward bias or the positive polarity. So, I_C current decreases.

Active region: ($I_{FB} - I_{RB}$)

E-B junction (Forward biased)

B-C junction (Reverse biased)

Through V_{CB} we get the current I_C . But further increasing the V_{CB} , I_C is not changing because I_C doesn't depend on V_{CB} , instead it depends on I_E current. As $I_C = \alpha(I_E)$ or $I_C \propto I_E$

Cut-off region: (I_{RB}) (I_{FB})

E-B junction (open means no supply i.e., $I_E = 0$)

B-C junction (Reverse biased)

So, if $I_E = 0$ then $I_C = 0$ (there is some leakage current which is negligible)

In the active region transistor work as an amplifier, whereas, in cut-off region it works as a switch.

- I_C varies with the V_{CB} only for few voltages less than 1V transistor is never operated in this region.
- When V_{CB} is increased to 1 or 2 V, I_C becomes constant and depends on I_E only. Here almost all emitter current flows through the collector and the transistor is operated in this region.
- A very large change in V_{CB} produces very small change in I_C , this indicates that the output resistance is very high.
- Beyond the particular value of V_{CB} , the reversed bias collector junction breaks down and the current increases rapidly. A transistor is not designed to operate in this region.

Output resistance :

$$r_o = \left. \frac{\Delta V_{CB}}{\Delta I_C} \right|_{I_E}$$

Thus, the r_o of common base circuit is very high approx. several tens K ohms..

(C) Current amplification factor (Alpha) $\propto \frac{V_{out}}{V_{in}}$

Ratio of the change in output Current to change in input current at constant V_{CB} is called Current amplifier factor.

$$\alpha = \left. \frac{\Delta I_C}{\Delta I_E} \right|_{V_{CB}}$$

$$I_E > I_C \Rightarrow \alpha < 1$$

α can be increased by dicing I_B , but it can't be made 1. This is achieved by making the base thin and doping it light. Practically value of α in commercial transistors range from 0.9 to 0.99.

B) Expression for collector current:

1. Part of emitter current that reaches collector (αI_E)
2. Leakage current (I_{CBO}). This current is due to the movement of minority carriers, BC junction on account of it being reverse biased.

$$I_C = \alpha I_E + I_{CBO} \quad \text{Total collector current.}$$

$$I_C = \alpha I_E + I_{CBO} \rightarrow ①$$

We know

$$I_E = I_C + I_B$$

$$I_C = \alpha(I_C + I_B) + I_{CBO}$$

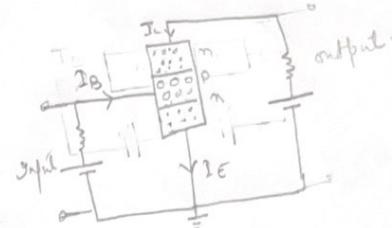
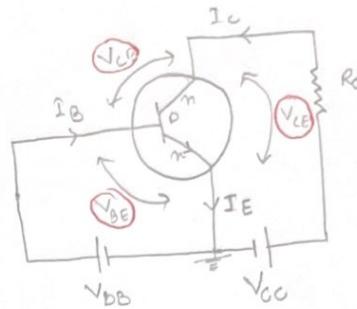
$$I_C(1 - \alpha) = \alpha I_B + I_{CBO}$$

$$\boxed{I_C = \frac{\alpha}{1-\alpha} I_B + \frac{1}{1-\alpha} I_{CBO}}$$

Common Emitter Configuration:-

The Common Emitter amplifier is a three basic single-stage BJT and is used as a voltage amplifier.

The input of this amplifier is taken from the base terminal, the output is collected from the collector terminal and the emitter terminal is common for both the terminals.



Working Principle:

Input characteristics: (the characteristic is same as p-n diode)

$$\begin{aligned} \text{Input current} &= I_B \\ \text{Output current} &= I_C \end{aligned}$$

$$\begin{aligned} I_E &= I_B + I_C \\ I_C &= \alpha I_E \end{aligned}$$

We have the Eqn:-

$$V_{CE} = V_{CB} + V_{BE} \rightarrow \text{fix}$$

at fixed V_{BE} , and vary V_{CE}

why I_B res with increase in V_{CE})

$V_{CE} \uparrow \rightarrow V_{CB} \uparrow \rightarrow$ Reverse bias

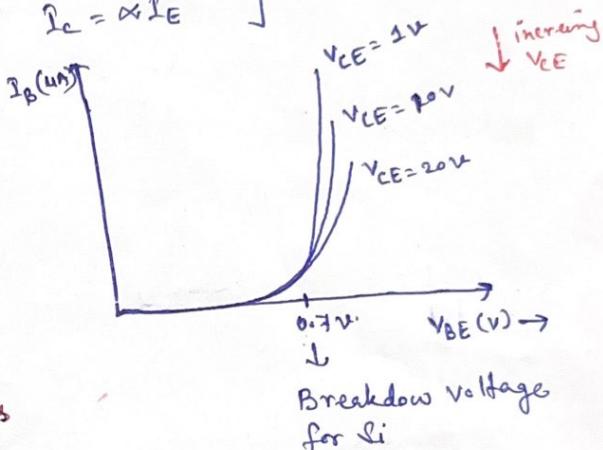
Depletion region thick

No. of holes less

recombination less. So lesser number of valence electron moves toward base.

so, I_B less

Q.E. $V_{CE} \uparrow \rightarrow I_B \downarrow$



* Input resistance:-

$$r_i = \frac{\Delta V_{BE}}{\Delta I_B} \mid_{V_{CE}}$$

Input resistance of CE configuration is higher than the input resistance of CB configuration.

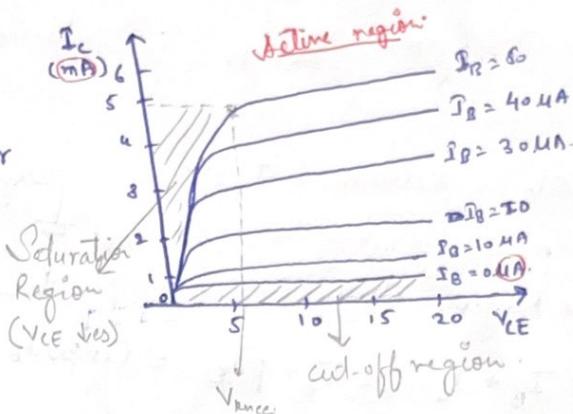
Output characteristics: (I_c, V_{CE}) at I_B .

Base Current Amplification factor (β):

The ratio of change in collector current to the change in base current is base current amplification.

$$\text{J-e } \beta = \frac{\Delta I_c}{\Delta I_B}$$

β changes from 20 to 500



μA → mA { Amplification of Current }

relation b/w α and β :

$$\beta = \frac{\Delta I_c}{\Delta I_B} \quad (\text{CE Configuration})$$

$$\alpha = \frac{\Delta I_c}{\Delta I_E} \quad (\text{CB Configuration})$$

We know,

$$I_E = I_B + I_C$$

$$\text{and } I_C = \alpha I_E$$

$$\beta = \frac{\alpha I_E}{\Delta I_B} = \frac{\alpha \Delta I_E}{(\Delta I_E - \Delta I_C)}$$

$$= \frac{\alpha \Delta I_E}{\Delta I_E \left(1 - \frac{\Delta I_C}{\Delta I_E}\right)}$$

$$\boxed{\beta = \frac{\alpha}{1 - \alpha}}$$

Expression for Collector Current: (in CE)

$$I_E = I_B + I_C \rightarrow ①$$

$$I_C = \alpha I_E + I_{CBO} \rightarrow ②$$

$$I_C = \frac{\alpha}{1-\alpha} I_B + \frac{1}{1-\alpha} I_{CBO} \rightarrow ③$$

If $I_B = 0$ (Base is open circuit), Collector current will flow to the emitter (i.e. I_{CEO} → collector cut off current with base open.)

$$I_{CEO} = \frac{I_{CBO}}{1-\alpha} \rightarrow ④$$

Substituting value of $\frac{I_{CBO}}{1-\alpha}$ in Eq. ③

$$I_C = \frac{\alpha}{1-\alpha} I_B + I_{CEO} \rightarrow ⑤$$

$$I_C = \beta I_B + I_{CEO}$$

$$I_C = \beta I_B + (1+\beta) I_{CBO}$$

$$\begin{cases} \beta = \frac{\alpha}{1-\alpha} \\ (1-\alpha)\beta = \gamma \\ 1+\beta = \frac{1}{1-\alpha}. \end{cases}$$

Current Amplifier

↓
slope value.
 $\frac{\alpha}{1-\alpha} \approx 0.99$

Now explain graph. → as we res I_B , I_C becomes βI_B (i.e. Amplification of current is there)

Fig.

Leakage in transistor is due to minority carrier and is independent of temperature.

I_E in term of β :

$$I_C = \beta I_B$$

$$I_E = I_C + I_B$$

$$= \beta I_B + I_B$$

$$I_E = (1+\beta) I_B$$

* Common Emitter Configuration is mostly used configuration Why?

Because it does amplification of voltage, current and power.

Mostly it is used for current and power amplification.

1. High current gain

$$I_c = \beta I_B + I_{CEO}$$

$$\beta \text{ is high} : I_c \gg I_B.$$

$$\left(\frac{\uparrow I_c}{\uparrow I_B} \right)$$

2. High voltage and power gain

3. Moderate output to input impedance ratio.

In CE configuration ratio of output impedance to input impedance is small i.e. about 50, this makes CE circuit arrangement ideal one for coupling b/w various transistor stages.

Q. The constant α of a transistor is 0.95. What would be the change in the collector current corresponding to a change of 0.4mA in the base current in the common emitter configuration.

$$\begin{aligned} \text{Given } \alpha &= 0.95 \\ \Delta I_B &= 0.4 \text{ mA} \\ \Delta I_C &=? \end{aligned}$$

$$\begin{aligned} \therefore \beta &= \frac{\alpha}{1-\alpha} \\ &= \frac{0.95}{1-0.95} = 19 \end{aligned}$$

$$\text{Also } \beta = \frac{\Delta I_C}{\Delta I_B}$$

$$\begin{aligned} \Delta I_C &= \beta \times \Delta I_B \\ &= 19 \times 0.4 \text{ mA} \end{aligned}$$

$$\therefore \boxed{\Delta I_C = 7.6 \text{ mA}}$$

Ans: In the CE configuration, the voltage drop across a resistance of $6\text{k}\Omega$ connected in the collector circuit is 6 volts. If the current gain in the CB configuration of a transistor is 0.995, then find the base current I_B .

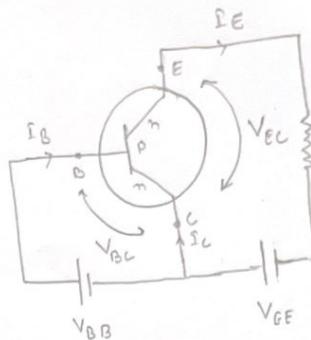
$$\begin{aligned} \text{Given } R_L &= 6\text{k}\Omega, V_o = 6V, \alpha = 0.995 \\ \therefore \beta &= \frac{\alpha}{1-\alpha} \Rightarrow \frac{0.995}{1-0.995} = 199 \end{aligned}$$

$$\begin{aligned} \text{Also } \beta &= \frac{I_C}{I_B} \\ &= \frac{(N_0/R_L)}{I_B} \\ 199 &= \frac{(6V/6\text{k}\Omega)}{I_B} \Rightarrow I_B = 8.02 \mu\text{A} \end{aligned}$$

3. Common Collector (CC) :-

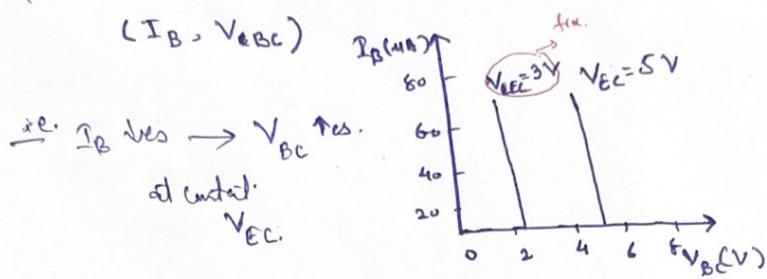
In this configuration, the base terminal of the transistor serves as the input, the emitter terminal is the output and the collector terminal is common for both input and output.

The input is applied between the base and collector while the output is taken from the emitter and collector.



Working Principle:-

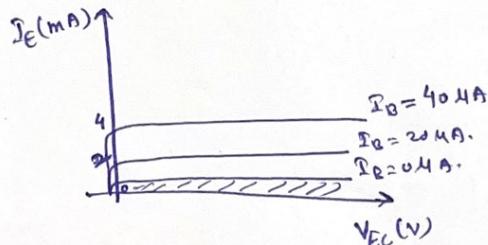
Input characteristics :-



Output characteristics :-

"Saturation" (BJT diode F-B)

ii. Active region.



Dynamic Input resistance:

$$r_i = \frac{\Delta V_{BE}}{\Delta I_B} \quad | \text{ at } V_{CE} = \text{const.}$$

Dynamic output resistance:

$$r_o = \frac{\Delta V_{CE}}{\Delta I_E}, \quad I_B = \text{const.}$$

i) Current Amplifier factor (γ): (in CC)

$$\gamma = \frac{\Delta I_E}{\Delta I_B}$$

$$\text{as } \Delta I_E \approx \Delta I_C.$$

This configuration also provides the same current gain as in Common Emitter.

Relation b/w γ and α :

$$\gamma = \frac{\Delta I_E}{\Delta I_B}$$

$$\alpha = \frac{\Delta I_C}{\Delta I_B} \quad (\text{Current Amplifier Gain in CB})$$

$$I_E = I_B + I_C$$

$$\gamma = \frac{\Delta I_E}{\Delta I_E - \Delta I_C}$$

$$\gamma = \frac{1}{1 - \frac{\Delta I_C}{\Delta I_E}}$$

$$\boxed{\gamma = \frac{1}{1-\alpha}}$$

ii) Expression for Collector Current:

$$I_C = \alpha I_E + I_{CBO} \rightarrow ①$$

$$I_E = I_C + I_B \rightarrow ②$$

$$= \alpha I_E + I_{CBO} + I_B$$

$$(1-\alpha) I_E = I_B + I_{CBO}$$

$$I_E = \frac{1}{1-\alpha} I_B + \frac{1}{1-\alpha} I_{CBO}$$

$$\boxed{I_E = (1+\beta) I_B + (1+\beta) I_{CBO}}$$

$$\left(\begin{array}{l} \therefore \beta = \frac{\alpha}{1-\alpha} \\ (1-\alpha)\beta = \alpha \\ 1+\beta = \frac{1}{1-\alpha} \end{array} \right)$$

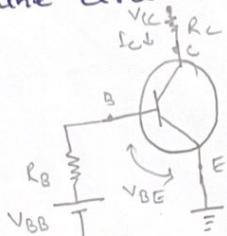
Q. Why CC Configuration is not used for Amplification?

This configuration has high input resistance & low output resistance hence voltage gain < 1 , ~~so~~ hence CC Configuration is not used for Amplification. ~~This~~ It is generally used for impedance matching i.e. for deriving ~~a~~ low impedance load and high impedance source.

Q. Why CE is mostly used Configuration?

* DC Analysis & DC Load Line:

In case of amplifier, it has two input AC + DC input. If we analyse the circuit as DC input it is called DC analysis.



What is DC load line?

In a graph which has all possible values of output current I_C and output voltage V_{CE} . So applying KVL to the output of CE config. we get,

$$V_{CC} = I_C R_C + V_{CE}$$

$$V_{CC} - I_C R_C - V_{CE} = 0$$

$$I_C R_C = -V_{CE} + V_{CC}$$

$$I_C = -\frac{1}{R_C} V_{CE} + \frac{V_{CC}}{R_C} \rightarrow (A)$$

In order to get a line, we required minimum two points. So, to get the points. put

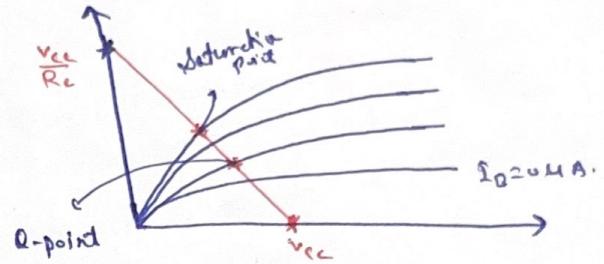
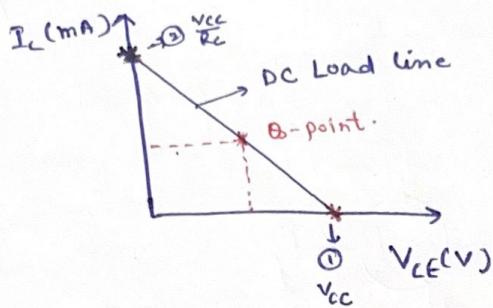
i) $I_C = 0$ in Eqn. (A)

then $V_{CE} = V_{CC}$ \rightarrow ①

ii) $V_{CE} = 0$ in Eqn. (A)

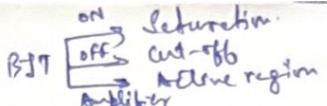
So, $I_C = \frac{V_{CC}}{R_C}$ \rightarrow ②

DC Load line in output characteristics.



Now, comes. Q -point / operating point:

- Zero signal value of I_C and V_{CE} are known as - the operating point. When a signal is applied variation of I_C + V_{CE} takes place about the line.
- For a faithful amplification we select Q -point at exactly middle of the plot.

Transistor Biasing :- BJT  The regions are labeled: ON saturation, OFF cut-off, and Active region.

The proper flow of zero signal collector current, and the maintenance of proper collector-emitter voltage during the passage of signal is known as Transistor Biasing.

To obtain the faithful amplification in a transistor, it is required the transistor in active region.

Biasing circuit : (Basic purpose of transistor)

In transistor biasing we want to keep BE junction FB and CB junction properly RB during the application of signal, which can be done by adjusting a bias battery in the circuit. The circuit that provide the transistor biasing is called the Biasing Circuit.

What is Stabilization : (Means to make the operating point independent of T)

Semi-conductor show temperature dependent characteristics and hence the operating point also changes with temperature, which is undesirable. → The process of making operating point independent of Temperature changes or variation in transistor parameters is known as Stabilization.

The unstable Q-point causes the thermal runaway.

$$I_c = \beta I_B + (1+\beta) I_{CBO} \rightarrow ①$$

I_{CBO} is the collector leakage current which is highly influenced by the temperature & \uparrow es by 10°C temp. doubles the I_{CBO} which is an experimentally verified fact. So, from eqn. ① $I_c \uparrow$ es by $(1+\beta) I_{CBO}$ times, hence \uparrow es in I_c .

is shift the operating point.

2. This high I_c current when flows produces heat within the transistor. This \uparrow es the transistor temp. & hence I_{CBO} further \uparrow es in I_{CBO} , $I_c \uparrow$ es by $(1+\beta) I_{CBO}$. This \uparrow es I_c will further raised the temperature.

This effect is cumulative and I_c in second I_c becomes \uparrow es large & hence burn the transistor.

→ self destruction of an unstabilized transistor is known as thermal runaway.

Hence for stability of operating point I_c should kept constant irrespective of change in I_{CBO} . This implies that I_c can be const. by using I_B .

Stability factor: (S)

The extend to which biasing circuit is capable of keeping I_c constant with variation in I_{CBO} is defined in term of stability factor

$$S = \frac{dI_c}{dI_{CBO}} \quad \text{at const. } \beta \text{ or } I_B$$

→ Ideal value of $S=1$, (not possible to attain this value).

→ performance is satisfactory for $S < 25$.

expression for S for a transistor in CE Configuration:

$$I_c = \beta I_B + (1+\beta) I_{CBO}$$

Diffr. wrt I_c

$$1 = \beta \frac{dI_B}{dI_c} + (1+\beta) \frac{dI_{CBO}}{dI_c} \rightarrow Y_S$$

$$1 = \beta \frac{dI_B}{dI_c} + \frac{(1+\beta)}{S}$$

$$\boxed{S = \frac{(1+\beta)}{1 - \beta \left(\frac{dI_B}{dI_c} \right)}}$$

General Eqⁿ. for Stability factor.

→ Lower the value of S , better is the thermal stability of the transistor.

→ How or by which changes change collector current.

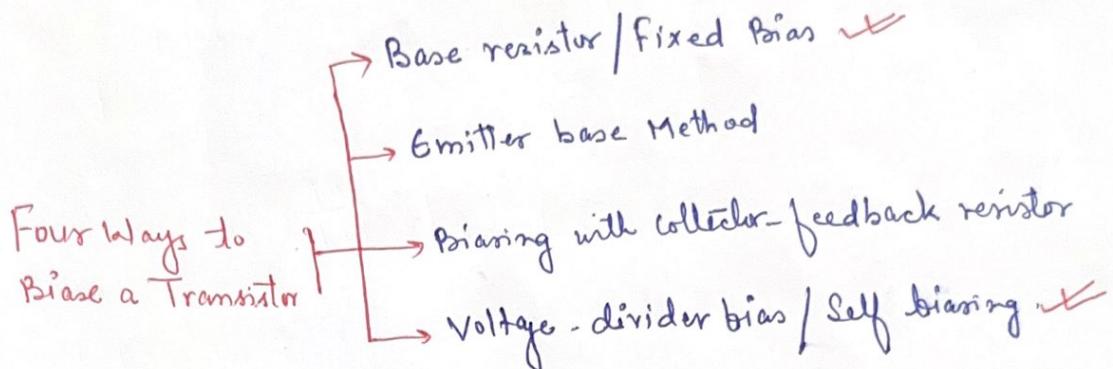
→ Why stabilization of operating point is necessary.

→ What is thermal runaway.

→ How thermal runaway is avoided.

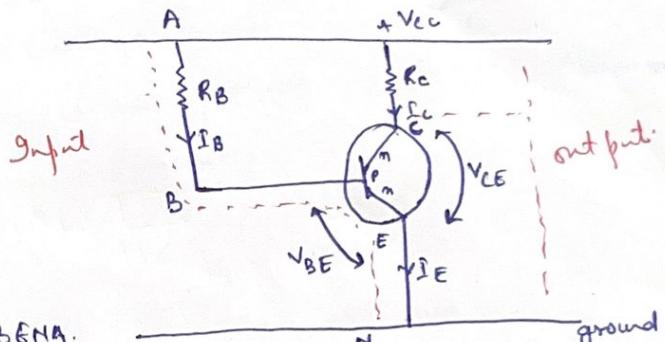
Q) Polarizing a transistor is needed or essential?
 Transistor biasing is done to get faithful amplification. So for that the following 3-points should be proper.

- i) It should ensure proper zero signal current.
- ii) It should ensure that V_{CE} does not fall below 0.5 V for Ge and 3 V for Si transistor.
- iii) It should ensure the stabilization of operating point.



①. Fixed Bias:-

- Input
- Output
- Stability factor
- Load line
-



Applying KVL to input ABEN.

$$V_{CC} = I_B R_B + V_{BE}$$

$$I_B = \frac{V_{CC} - V_{BE}}{R_B}$$

$$\text{or } R_B = \frac{V_{CC} - V_{BE}}{I_B}$$

as $V_{CC} > V_{BE}$

$$R_B \approx \frac{V_{CC}}{I_B} \rightarrow ②$$

here, V_{CC} is fixed quantity and I_B is chosen at some suitable value, hence R_B can be found directly and for this reason, this method is called fixed bias method.

Stability factor:

$$S = \frac{1 + \beta}{1 - \beta \frac{dI_B}{dI_C}}$$

Differentiate I_B in Eq. ① w.r.t I_B

$$\frac{dI_B}{dI_C} = 0$$

$$\text{Hence, } S = \frac{1 + \beta}{1 - \beta(0)}$$

$$S = 1 + \beta$$

Comments:

$$S = 1 + \beta$$

$$\text{i.e. } \frac{dI_C}{dI_{CB0}} = 1 + \beta$$

$$\text{or } dI_C = (1 + \beta)dI_{CB0}$$

i.e. I_C changes $(1 + \beta)$ times as much as I_{CB0} changes.
Hence, the fixed bias circuit provides poor thermal stability.
hence, prone to thermal runaway.

→ For output loop:

$$V_{CC} = I_C R_C + V_{CE}$$

$$\text{and } I_C = \beta I_B.$$

So, change in R_C will not affect I_B or I_C as long as we are in active region. However R_C will determine the magnitude of V_{CE} .

dead line Analysis:

From Eq. ①

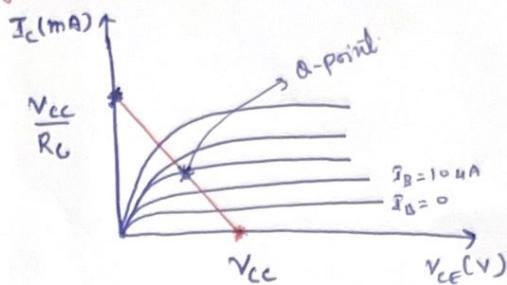
$$V_{CE} = V_{CC} - I_C R_C$$

case i)

$$V_{CE}|_{I_C=0} = V_{CC}$$

case ii) $V_{CE} = 0$

$$I_C|_{V_{CE}=0} = \frac{V_{CC}}{R_C}$$



i.e Q-point changes by changing the following parameters.

- i) I_C can change by varying I_B
- ii) if V_{CC} is fixed & R_C changes
- iii) if R_C is fixed and V_{CC} is changed.

Advantage:

- Simple.
- Calculations are simple.

Disadvantages:

- i) High S and hence strong chances of thermal runaway.
- ii) Poor stability - there is no means of stopping rise in I_C due to I_{BO} , as I_B is always fixed.